

MOSFET Power Transistor

BLF348

65V / 25A

DATASHEET

OEM – Philips

Source: Philips Data Handbook SC19a 1998

VHF linear push-pull power MOS transistor**BLF348****FEATURES**

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability.

DESCRIPTION

Dual push-pull silicon N-channel enhancement mode vertical D-MOS transistor, designed for broadcast transmitter applications in the VHF frequency range.

The transistor is encapsulated in a 4-lead, SOT262 A1 balanced flange envelope, with two ceramic caps. The mounting flange provides the common source connection for the transistors.

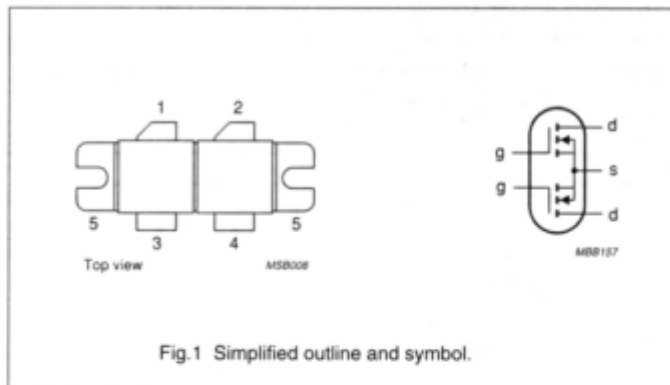
PIN CONFIGURATION

Fig.1 Simplified outline and symbol.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static charge during transport and handling.

PINNING – SOT262A1

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | drain 1 |
| 2 | drain 2 |
| 3 | gate 1 |
| 4 | gate 2 |
| 5 | source |

WARNING**Product and environment safety - toxic materials**

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance in a push-pull common source test circuit.

| MODE OF OPERATION | f_{vision} (MHz) | V_{DS} (V) | I_{D} (A) | T_{h} (°C) | d_{im} (dB) (note 1) | $P_{\text{O sync}}$ (W) | G_{p} (dB) |
|-------------------|------------------------------|------------------------|-----------------------|------------------------|-------------------------------------|----------------------------|------------------------|
| class-A | 224.25 | 28 | 2×4.6 | 70 | -52 | > 67 | > 11 |
| | 224.25 | 28 | 2×4.6 | 25 | -52 | typ. 75 | typ. 13 |

Note

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB), zero dB corresponds to peak synchronization level.

VHF linear push-pull power MOS transistor

BLF348

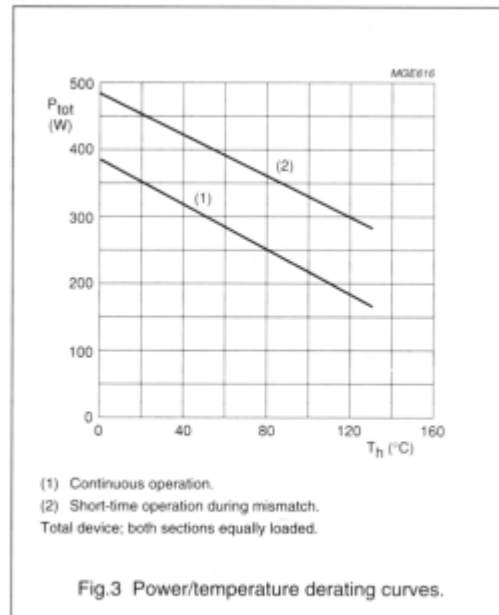
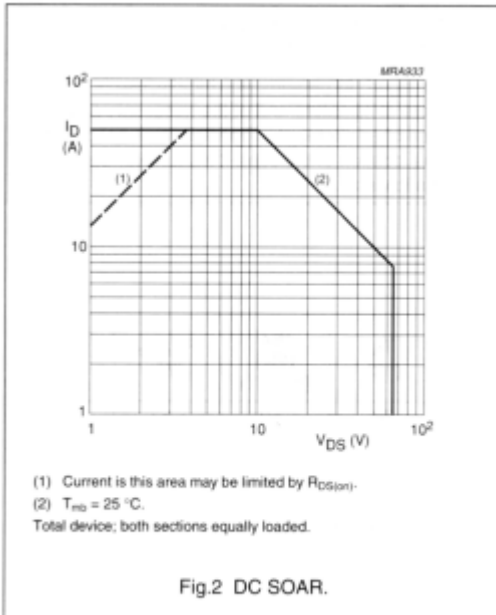
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).
Per transistor section unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------|-------------------------|---|------|------|------------------|
| V_{DSS} | drain-source voltage | | – | 65 | V |
| $\pm V_{GS}$ | gate-source voltage | | – | 20 | V |
| I_D | DC drain current | | – | 25 | A |
| P_{tot} | total power dissipation | up to $T_{mb} = 25\text{ }^\circ\text{C}$; total device; both sections equally loaded | – | 500 | W |
| T_{stg} | storage temperature | | –65 | 150 | $^\circ\text{C}$ |
| T_j | junction temperature | | – | 200 | $^\circ\text{C}$ |

THERMAL RESISTANCE

| SYMBOL | PARAMETER | CONDITIONS | THERMAL RESISTANCE |
|----------------|---|---|--------------------|
| $R_{th\ j-mb}$ | thermal resistance from junction to mounting base | total device; both sections equally loaded | 0.35 K/W |
| $R_{th\ mb-h}$ | thermal resistance from mounting base to heatsink | total device; both sections equally loaded | 0.15 K/W |



VHF linear push-pull power MOS transistor

BLF348

CHARACTERISTICS (per section) $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--|--|------|------|------|---------------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $V_{GS} = 0; I_D = 0.1\text{ A}$ | 65 | - | - | V |
| I_{DSS} | drain-source leakage current | $V_{GS} = 0; V_{DS} = 28\text{ V}$ | - | - | 5 | mA |
| I_{GSS} | gate-source leakage current | $\pm V_{GS} = 20\text{ V}; V_{DS} = 0$ | - | - | 1 | μA |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D = 0.1\text{ A}; V_{DS} = 10\text{ V}$ | 2 | - | 4.5 | V |
| $\Delta V_{GS(th)}$ | gate-source voltage difference of both transistor sections | $I_D = 0.1\text{ A}; V_{DS} = 10\text{ V}$ | - | - | 100 | mV |
| g_{fs} | forward transconductance | $I_D = 8\text{ A}; V_{DS} = 10\text{ V}$ | 5 | 7.5 | - | S |
| g_{fs1}/g_{fs2} | forward transconductance ratio of both transistor sections | $I_D = 8\text{ A}; V_{DS} = 10\text{ V}$ | 0.9 | - | 1.1 | |
| $R_{DS(on)}$ | drain-source on-state resistance | $I_D = 8\text{ A}; V_{GS} = 10\text{ V}$ | - | 0.1 | 0.15 | Ω |
| I_{DSX} | on-state drain current | $V_{GS} = 10\text{ V}; V_{DS} = 10\text{ V}$ | - | 37 | - | A |
| C_{is} | input capacitance | $V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$ | - | 495 | - | pF |
| C_{os} | output capacitance | $V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$ | - | 340 | - | pF |
| C_{rs} | feedback capacitance | $V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$ | - | 40 | - | pF |